INCH-POUND

MIL-M-38510/350A

26 May 2004

SUPERSEDING

MIL-M-38510/350

24 June 1985

## MILITARY SPECIFICATION

# MICROCIRCUITS, DIGITAL, BIPOLAR, ADVANCED SCHOTTKY TTL, QUAD 2-PORT REGISTERS, CASCADABLE, MONOLITHIC SILICON

Reactivated after 26 May 2004 and may be used for either new or existing design acquisition.

This specification is approved for use by all Departments and Agencies of the Department of Defense.

The requirements for acquiring the product herein shall consist of this specification sheet and MIL-PRF 38535

- 1. SCOPE
- 1.1 <u>Scope.</u> This specification covers the detail requirements for monolithic silicon, advanced Schottky TTL, quad 2-port register microcircuits. Two product assurance classes and a choice of case outlines and lead finishes are provided for each type and are reflected in the complete part number. For this product, the requirements of MIL-M-38510 have been superseded by MIL-PRF-38535, (see 6.3).
  - 1.2 Part or Identifying Number (PIN). The PIN is in accordance with MIL-PRF-38535, and as specified herein.
  - 1.2.1 <u>Device types</u>. The device types are as follows:

Device type	<u>Circuit</u>
01	Quad 2-port cascadable register with both inverted and non-inverted outputs
02	Quad 2-port cascadable register with non-inverted outputs

- 1.2.2 <u>Device class.</u> The device class is the product assurance level as defined in MIL-PRF-38535.
- 1.2.3 Case outlines. The case outlines are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	<u>Terminals</u>	Package style
E	GDIP1-T16 or CDIP2-T16	16	Dual-in-line
F	GDFP2-F16 or CDFP3-F16	16	Flat pack
R	GDIP1-T20 or CDIP2-T20	20	Dual-in-line
S	GDFP2-F20 or CDFP3-F20	20	Flat pack
2	CQCC1-N20	20	Square leadless chip carrier

Comments, suggestions, or questions on this document should be addressed to: Commander, Defense Supply Center Columbus, ATTN: DSCC-VAS, P. O. Box 3990, Columbus, OH 43218-3990, or emailed to bipolar@dscc.dla.mil. Since contact information can change, you may want to verify the currency of this address information using the ASSIST Online database at www.dodssp.daps.mil.

AMSC N/A FSC 5962

# 1.3 Absolute maximum ratings.

Supply voltage range Input voltage range Storage temperature range Maximum power dissipation, per device (P <sub>D</sub> ) 1/ Device type 01 Device type 02 Lead temperature (soldering, 10 seconds) Thermal resistance, junction to case (θ <sub>JC</sub> ) Junction temperature (T <sub>J</sub> ) 2/  1.4 Recommended operating conditions.	-1.2 V dc at -18 mA to +7.0 V dc -65° to +150°C 209 mW 187 mW +300°C (See MIL-STD-1835)
Supply voltage (V <sub>CC</sub> )	4.5 V dc minimum to 5.5 V dc maximum
Minimum high level input voltage (V <sub>IH</sub> )	
Maximum low level input voltage (V <sub>IL</sub> )	
	0.6 V dC
Normalized fanout (each output) <u>3</u> /:	22
Low level	
High level	
Case operating temperature range (T <sub>C</sub> )	-55° to +125°C
Width of clock pulse high:	
Device type 01, 02	4.0 ns minimum
Width of clock pulse low:	
Device type 01, 02	7.0 ns minimum
Setup time in high to clock pulse:	
Device type 01, 02	4.5 ns minimum
Setup time in low to clock pulse:	
Device type 01, 02	4.5 ns minimum
Setup time S high to clock pulse:	
Device type 01	10.5 ns minimum
Device type 02	9.5 ns minimum
Setup time S low to clock pulse:	
Device type 01	10.5 ns minimum
Device type 02	
Hold time in high to clock pulse:	
Device type 01, 02	1.5 ns minimum
Hold time in low to clock pulse:	
Device type 01, 02	1.5 ns minimum
Hold time S high to clock pulse:	· · · · · · · · · · · · · · · · · ·
Device type 01, 02	0 ns minimum
Hold time S low to clock pulse:	
Device type 01, 02	0 ns minimum
20.00 ,, 02	

# 2. APPLICABLE DOCUMENTS

2.1 General. The documents listed in this section are specified in sections 3, 4, or 5 of this specification. This section does not include documents cited in other sections of this specification or recommended for additional information or as examples. While every effort has been made to ensure the completeness of this list, document users are cautioned that they must meet all specified requirements of documents cited in sections 3, 4, or 5 of this specification, whether or not they are listed.

 $<sup>\</sup>underline{1}$ / Must withstand the added  $P_D$  due to short-circuit test (e.g.,  $I_{OS}$ ).

Maximum junction temperature should not be exceeded except in accordance with allowable short duration burn-in screening condition in accordance with MIL-PRF-38535.

<sup>3/</sup> The device should fanout in both high and low levels to specified number of inputs of the same device type as that being tested.

# 2.2 Government documents.

2.2.1 <u>Specifications and Standards</u>. The following specifications and standards form a part of this specification to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

# DEPARTMENT OF DEFENSE SPECIFICATIONS

MIL-PRF-38535 - Integrated Circuits (Microcircuits) Manufacturing, General Specification for.

# DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard for Microelectronics.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines

(Copies of these documents are available online at http://assist.daps.dla.mil/quicksearch/ or www.dodssp.daps.mil or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.3 <u>Order of precedence.</u> In the event of a conflict between the text of this specification and the references cited herein, the text of this document takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

## 3. REQUIREMENTS

- 3.1 <u>Qualification</u>. Microcircuits furnished under this specification shall be products that are manufactured by a manufacturer authorized by the qualifying activity for listing on the applicable qualified manufacturers list before contract award (see 4.3 and 6.4).
- 3.2 <u>Item requirements</u>. The individual item requirements shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.
- 3.3 <u>Design, construction, and physical dimensions.</u> The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein.
  - 3.3.1 Terminal connections. The terminal connections shall be as specified on figure 1.
  - 3.3.2 Truth tables. The truth tables shall be as specified on figure 2.
  - 3.3.3 Logic diagrams. The logic diagrams shall be as specified on figure 3.
- 3.3.4 <u>Schematic circuits</u>. The schematic circuits shall be maintained by the manufacturer and made available to the qualifying activity and the preparing activity upon request.
  - 3.3.3 Case outlines. The case outlines shall be as specified in 1.2.3.

- 3.4 Lead material and finish. The lead material and finish shall be in accordance with MIL-PRF-38535 (see 6.6).
- 3.5 <u>Electrical performance characteristics</u>. The electrical performance characteristics are as specified in table I, and apply over the full recommended case operating temperature range, unless otherwise specified.
- 3.6 <u>Electrical test requirements</u>. The electrical test requirements for each device class shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table III.
  - 3.7 Marking. Marking shall be in accordance with MIL-PRF-38535.
- 3.8 <u>Microcircuit group assignment.</u> The devices covered by this specification shall be in microcircuit group number 12 (see MIL-PRF-38535, appendix A).

# 4. VERIFICATION

- 4.1 <u>Sampling and inspection.</u> Sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not effect the form, fit, or function as described herein.
- 4.2 <u>Screening.</u> Screening shall be in accordance with MIL-PRF-38535 and shall be conducted on all devices prior to qualification and conformance inspection. The following additional criteria shall apply:
  - a. The burn-in test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
  - b. Interim and final electrical test parameters shall be as specified in table II, except interim electrical parameters test prior to burn-in is optional at the discretion of the manufacturer.
  - c. Additional screening for space level product shall be as specified in MIL-PRF-38535.
  - 4.3 Qualification inspection. Qualification inspection shall be in accordance with MIL-PRF-38535.
- 4.4 <u>Technology Conformance inspection (TCI).</u> Technology conformance inspection shall be in accordance with MIL-PRF-38535 and herein for groups A, B, C, and D inspections (see 4.4.1 through 4.4.4).
- 4.4.1 <u>Group A inspection.</u> Group A inspection shall be in accordance with table III of MIL-PRF-38535 and as follows:
  - a. Tests shall be as specified in table II herein.
  - b. Subgroups 4, 5, and 6 shall be omitted.

TABLE I. <u>Electrical performance characteristics.</u>

Test	Symbol	Conditions	Device	Lir	nits	Unit
		$-55^{\circ}\text{C} \le T_{\text{C}} \le +125^{\circ}\text{C}$ unless otherwise specified	type	Min	Max	
High level output voltage	V <sub>OH</sub>	$V_{CC} = 4.5 \text{ V}, V_{IL} = 0.8 \text{ V},$ $I_{OH} = -1.0 \text{ mA}, V_{IH} = 2.0 \text{ V}$	All	2.5		V
Low level output voltage	V <sub>OL</sub>	V <sub>CC</sub> = 4.5 V, I <sub>OL</sub> = 20 mA, V <sub>IH</sub> = 2.0 V, V <sub>IL</sub> = 0.8 V	All		0.5	V
Input clamp voltage	V <sub>IC</sub>	$V_{CC} = 4.5 \text{ V}, I_{IN} = -18 \text{ mA},$ $T_{C} = +25^{\circ}\text{C}$	All		-1.2	V
High level input current	I <sub>IH1</sub>	$V_{CC} = 5.5 \text{ V}, V_{IN} = 2.7 \text{ V}$	All		20	μА
	I <sub>IH2</sub>	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 7.0 V	All		100	μА
Low level input current	I <sub>IL</sub>	$V_{CC} = 5.5 \text{ V}, V_{IN} = 0.5 \text{ V}$	All	03	60	mA
Short circuit output current 1/	los	$V_{CC} = 5.5 \text{ V}, V_{IN} = 0 \text{ V}$	All	-60	-150	mA
Output drive current	I <sub>OD</sub>	V <sub>CC</sub> = 4.5 V, V <sub>OUT</sub> = 2.5 V V <sub>IN</sub> = 5.5 V	All	60		mA
Supply current	Icc	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = GND	01		38	mA
			02		34	
Propagation delay time low to high level		$V_{CC} = 5.0 \text{ V}, C_L = 50 \text{ pF} \pm 10\%,$ $R_L = 500 \Omega$				
CP to Q, $\overline{Q}$	t <sub>PLH</sub>		01	1.5	9.5	ns
CP to Q	t <sub>PLH</sub>		02	1.5	9.5	ns
Propagation delay time high to low level						
CP to Q, Q	t <sub>PHL</sub>		01	1.5	11.5	ns
CP to Q	t <sub>PHL</sub>		02	1.5	11.5	ns
Input clock frequency	f <sub>MAX</sub>		All	80		MHz

 $<sup>\</sup>underline{1}$ / Not more than one output should be shorted at a time.

TABLE II. Electrical test requirements.

	Subgroups	(see table III)
MIL-PRF-38535	Class S	Class B
test requirements	devices	devices
Interim electrical parameters	1	1
Final electrical test parameters	1*, 2, 3, 9,	1*, 2, 3, 7, 9
Group A test requirements	1, 2, 3, 7, 8, 9, 10, 11	1, 2, 3, 7, 8, 9, 10, 11
Group B electrical test parameters	1, 2, 3, 7,	N/A
when using the method 5005 QCI option	8, 9, 10, 11	
Group C end-point electrical parameters	1, 2, 3, 7,	1, 2, 3
	8, 9, 10, 11	
Group D end-point electrical parameters	1, 2, 3	1, 2, 3

<sup>\*</sup>PDA applies to subgroup 1.

- 4.4.2 Group B inspection. Group B inspection shall be in accordance with table II of MIL-PRF-38535.
- 4.4.3 <u>Group C inspection.</u> Group C inspection shall be in accordance with table IV of MIL-PRF-38535 and as follows:
  - a. End-point electrical parameters shall be as specified in table II herein.
  - b. The steady-state life test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
- 4.4.4 <u>Group D inspection.</u> Group D inspection shall be in accordance with table V of MIL-PRF-38535. End-point electrical parameters shall be as specified in table II herein.
  - $4.5\;$  Methods of inspection. Methods of inspection shall be specified as follows:
- 4.5.1 <u>Voltage and current.</u> All voltages given are referenced to the microcircuit ground terminal. Currents given are conventional and positive when flowing into the referenced terminal.

	Device type 01	Device t	type 02
Terminal	Cases	Cases	Case
number	R, S, and 2	E and F	2
1	S	S	N/C
2	QA	QA	S
3	$\overline{QA}$	I0A	QA
4	IOA	I1A	I0A
5	I1A	I1B	I1A
6	I1B	I0B	N/C
7	I0B	QB	I1B
8	QB	GND	I0B
9	QB	СР	QB
10	GND	QC	GND
11	CP	I0C	N/C
12	QC	I1C	CP
13	QC	I1D	QC
14	IOC	I0D	IOC
15	I1C	QD	I1C
16	I1D	V <sub>cc</sub>	N/C
17	I0D		I1D
18	QD		I0D
19	QD		QD
20	Vcc		Vcc

FIGURE 1. <u>Terminal connections</u>.

Device type 01

TRU	ITH TAE	BLE EACI	H REGIS	TER											
	INPUTS OUTPUTS														
S	10	I1	Q	IQ											
I	I	Х	L	Н											
I	h	Χ	Н	L											
h	Х	I	L	Н											
h	Χ	h	Н	L											

- I = Low voltage level one setup time prior to the low to high clock transition
- h = High voltage level one setup time prior to the low to high clock transition
- L = Low voltage level.
- H = High voltage level.
- X = Immaterial

Device type 02

TRU	TH TABLE	E EACH F	REGISTER												
	INPUTS OUTPUTS S I0 I1 Q														
S	10	<b>I</b> 1	Q												
I	I	Х	L												
I	h	X	Н												
h	Х	-	L												
h	Х	h	Н												

- I = Low voltage level one setup time prior to the low to high clock transition
- h = High voltage level one setup time prior to the low to high clock transition
- L = Low voltage level.
- H = High voltage level.
- X = Immaterial

FIGURE 2. Truth tables.

# DEVICE TYPE 01 IOA -O D — QA **→** <del>Q</del>A ОСР I1A -IOB — – QB | — <u>Ω</u>Β ОСР I1B — IOC — O D — QC b− <u>ac</u> CP 11C — IOD — O D **О**СР 11D -

FIGURE 3. Logic diagram.

# DEVICE TYPE 02 IOA -- QA O CP I1A -IOB -- D − QB O CP I1B -IOC d D — QC O CP I1C — IOD — -CP I1D -CP —

FIGURE 3. <u>Logic diagram</u> - Continued.

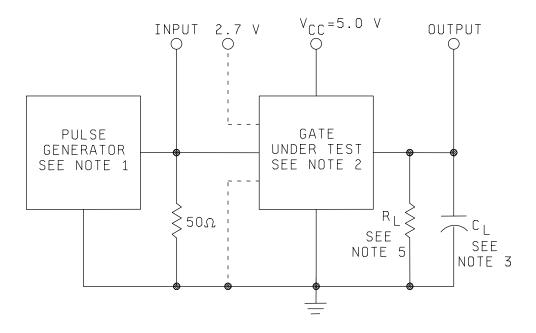
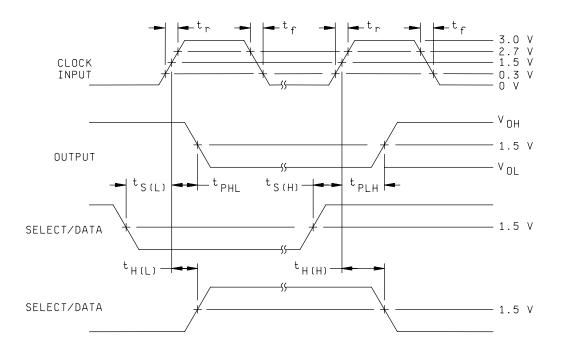


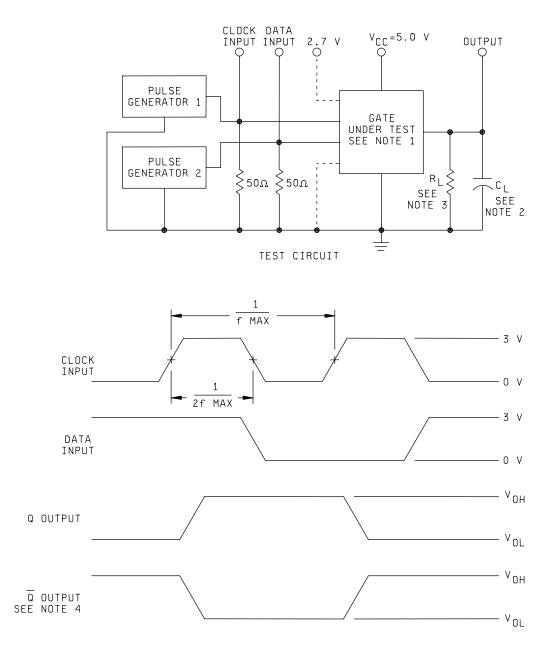
FIGURE 4. Switching test circuit.



# NOTES:

- 1. Pulse generator has the following characteristics:  $t_r = t_f \le 2.5$  ns, PRR  $\le 1$  MHz,  $Z_{OUT} \approx 50\Omega$ .
- 2. Inputs not under test are at 2.7 V or GND as specified in table III.
- 3.  $C_L = 50 \text{ pF} \pm 10\%$ . including scope, probe, wiring, and stray capacitance, without package in test fixture.
- 4. Voltage measurements are to be made with respect to network ground terminal.
- 5.  $R_L = 500\Omega \pm 5\%$ .
- 6. Setup and hold times, rising-edge clock for select input and data input.

FIGURE 4. Switching test circuit - Continued.



# NOTES:

- 1. Inputs not under test are at 2.7 V or GND as specified in table III.
- 2.  $C_L = 50 \text{ pF} \pm 10\%$  including scope, probe, wiring, and stray capacitance, without package in test fixture.
- 3.  $R_L = 500\Omega \pm 5\%$ .
- 4. Device type 01 only.

FIGURE 5. Input clock frequency test circuit (all device types).

TABLE III. Group A inspection for device type 01.

Terminal conditions (pins not designated may be high  $\ge 2.0 \text{ V}$ : low  $\le 0.8 \text{ V}$ ; or open).

		MIL-STD-	Cases	1	2	3	4	5	6	7	8	9	10	11	12	13	14	0.8 V; c	16	17	18	19	20				Т
Subgroup	Symbol		R, S, 2																					Measured		limits	Unit
		method	Test no.	S	QA	QA	IOA	I1A	I1B	I0B	QB	QB	GND	CP	QC	QC	IOC	I1C	I1D	I0D	QD	QD	V <sub>CC</sub>	terminal	Min	Max	
1	V <sub>OH</sub>	3006	1	0.8 V		-1 mA	0.8 V	5.5 V	5.5 V	5.5 V			GND	<u>1</u> /			5.5 V	5.5 V	5.5 V	5.5 V			4.5 V	QA	2.5		V
rc = 25°C			2	"			0.0 V	"	"	0.8 V	-1 mA		"	"			5.5 V	"					"	QB	"		"
			3				"	"		0.0 V			"			-1 mA	0.8 V	"		"			"	QC	"		"
			4				"	"	"	"			"				0.0 V	"		0.8 V	-1 mA		"	QD	"		٠.
			5		-1 mA		2.0 V	0.0 V	0.0 V								"	0.0 V	0.0 V	0.0 V				QD QA			-
			6	"			5.5 V	"	"	2.0 V		-1 mA	"				"	"	"	"			"	QB			-
			7					"		5.5 V				"	-1 mA		2.0 V	"	"	-				QC			
			8	0.01/		4 1		0.01/	"	-			-				5.5 V	551/	" 5.5.\/	2.0 V		-1 mA	- "	QD			₩.
			9	2.0 V		-1 mA	-	0.8 V	5.5 V				-					5.5 V	5.5 V	5.5 V				QA	-		
		"	10				"	0.0 V	0.8 V	"	-1 mA		"				"	5.5 V					"	QB	"		
			11	"			"	"	0.0 V	"			"			-1 mA		0.8 V						QC	"		"
		"	12	"			"	"	"	"			"	"			"	5.5 V	0.8 V	"	-1 mA		"	QD	"		"
			13		-1 mA		0.0 V	2.0 V	"	0.0 V							0.0 V	0.0 V	0.0 V	0.0 V			"	QA			-
			14	"			"	5.5 V	2.0 V	"		-1 mA	"				"	0.0 V	"	"			"	QB	"		-
			15	"					5.5 V	"				-	-1 mA			2.0 V	"	-				QC	-		
			16					"	"	"			"	"			"	5.5 V	2.0 V			-1 mA	"	QD	"		
	V <sub>OL</sub>	3007	17	0.8 V	20 mA		0.8 V	- "		5.5 V		00 4	- "-				5.5 V	5.5 V	5.5 V	5.5 V			- "	QA		0.5	<del>⊢</del> :
			18				0.0 V			0.8 V		20 mA					5.5 V							QB			
			19 20							0.0 V					20 mA		0.8 V 0.0 V			0.8 V		20 mA	- "	QC QD			+-
			21			20 mA	2.0 V	0.0 V	0.0 V								0.0 V	0.0 V	0.0 V	0.0 V		20 MA	"	QA QA		"	+-
			22				5.5 V	"	"	2.0 V	20 mA		"				"	"					"				٠.
			23				"	"		5.5 V	20					20 mA	2.0 V	"						QB		-	
								"		3.3 V						20111A	5.5 V			2.0 V	20 mA			QC		-	-
			24														5.5 V			2.0 V	20 MA			$\overline{QD}$			
			25	2.0 V	20 mA		-	0.8 V						-			"	5.5 V	5.5 V	5.5 V			=	QA		"	-
			26 27				- :	0.0 V	0.8 V 0.0 V	= =		20 mA		-	20 mA		"	5.5 V 0.8 V	- :				- "	QB QC		-:-	-
			28	-				"	0.0 V						20 IIIA		"	0.0 V	0.8 V			20 mA		QD		-	-
			29	"		20 mA	0.0 V	2.0 V	"	0.0 V			"	"			0.0 V	"	0.0 V	0.0 V			"	QA		"	"
		"	30	"			"	5.5 V	2.0 V	"	20 mA		"				"	"	"				"	QB		"	-
			31					"	5.5 V	"						20 mA	"	2.0 V					"	QC QC			-
			32					"	5.5 V	"							"	5.5 V	2.0 V		20 mA		"	QD QD			+-
	V <sub>IC</sub>		33	-18 mA					0.0 1				"					0.0 1	2.0 1		20		,	QD S		-1.2	
	VIC		34	-10 IIIA			-18 mA						"										"	IOA		-1.2	-
			35					-18 mA					"										"	I1A			<b>—</b>
			36						-18 mA				"										"	I1B		"	-
			37							-18 mA			"										"	I0B			
			38											-18 mA			40 4						- "	CP			-
			39 40		-	-	-	-				-	-			-	-18 mA	-18 mA		<u> </u>	-		"	IOC I1C		-	-
			41													1	1	210 IIIA	-18 mA		1		"	I1D			-
			42														1	1		-18 mA			"	IOD			-

See footnotes at end of device type 01.

TABLE III. Group A inspection for device type 01. Terminal conditions (pins not designated may be high  $\geq$  2.0 V; low  $\leq$  0.8 V; or open).

																	/; IOW ≤ (										
Subgroup	Symbol	MIL-STD- 883	Cases R, S, 2	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	Measured	Test	t limits	Unit
		method	Test no.	S	QA	QA	I0A	I1A	I1B	I0B	QB	QB	GND	CP	QC	QC	IOC	I1C	I1D	I0D	QD	QD	V <sub>cc</sub>	terminal	Min	Max	
1	I <sub>IH1</sub>	3010	43	2.7 V									GND										5.5 V	S		20	μA
Tc = 25°C		"	44				2.7 V	1															"	IOA	1	. "	
, ,		"	45	0.0 V				2.7 V					"		Ī								"	I1A			"
, ,		"	46	0.0 V			T '		2.7 V				"		Ī								"	I1B			"
, !			47				T '	,		2.7 V			"		Ī								"	I0B			"
, !			48											2.7 V									"	CP			"
, ,		"	49										"				2.7 V						"	I0C			"
, ,			50	0.0 V				T					"		1			2.7 V					"	I1C		"	"
, ,			51	0.0 V				T					"		1				2.7 V				"	I1D		"	"
, ,			52				†						"		1					2.7 V			"	I0D			-
, 1	I <sub>IH2</sub>	"	53	7.0 V			†						"		1								"	S		100	-
, ,	-1112		54			†	7.0 V	†			†				†		†	1					"	IOA		"	-
, ,			55	0.0 V		<b>†</b>	1	7.0 V			<b>—</b>		"		†	<b>†</b>		<b>†</b>					"	I1A			-
, ,			56	0.0 V		1	+		7.0 V		<b>†</b>		"		†		<b>†</b>						"	I1B			"
, ,			57				1	†		7.0 V	<b>†</b>				1		1	<b>†</b>					"	IOB			"
, ,			58			<b>—</b>	<del>                                     </del>				<b>†</b>		"	7.0 V	<b>†</b>		<b>†</b>	t					"	CP		-	-
, ,			59			<u> </u>	+				<b>—</b>		"		+	<b>—</b>	7.0 V						"	IOC			+ -
, ,		"	60	0.0 V			+	$\vdash$			<del>                                     </del>				<b>†</b>		1.0.	7.0 V	1		1		"	I1C	$\vdash$		-
, !			61	0.0 V		<u> </u>	+	$\vdash$			<b>—</b>		-		†	<b>—</b>	<b>†</b>	1.0.	7.0 V				"	I1D			-
, ,			62			$\vdash$	+	$\vdash$			<del>                                     </del>		"		1		<del>                                     </del>	<del></del>	1	7.0 V			"	IOD	-		
, ,	I <sub>IL</sub>	3009	63	0.5 V			+				<del>                                     </del>		"		1					7.0 7			"	S	4/	4/	mA
, ,	'IL	"	64	0.0 V			0.5 V				<del>                                     </del>				1								"	IOA	"	-7/	"
, ,			65	5.5 V		┼──	0.5 V	0.5 V			†				+	<del>                                     </del>	+	<del>                                     </del>					"	I1A			-
, ,			66	5.5 V		<del>                                     </del>	+	0.0 1	0.5 V		<del>                                     </del>		-	<b>—</b>	+	<del>                                     </del>	+	<del>                                     </del>					"	I1B			-
, ,			67	0.0 V		┼──	+	<del>                                     </del>	0.5 V	.05 V	†				+	<del>                                     </del>	+	<del>                                     </del>					"	IOB		-	-
, ,			68	5.5 V		<del>                                     </del>	+	<del>                                     </del>		.00 V	<del>                                     </del>			0.5 V	+	<del>                                     </del>	+	<del>                                     </del>						CP	-		+
, ,			69	0.0 V			+	<del>                                     </del>			+		-	0.5 V	+		0.5 V						"	IOC	-		+
, ,			70	5.5 V			+				+				+		0.5 V	0.5 V					"	I1C	-		-
, ,			71	5.5 V			+				+				+		+	0.5 V	0.5 V					I1D			-
, ,			72	0.0 V			+				+				+		+		0.5 V	0.5 V				IOD	-		-
, ,		3011	73	0.0 V	0.0 V		5.5 V	5.5 V			<del>                                     </del>			1/	+		+	<del></del>		0.5 V				QA	-60	-150	
, ,	Ios	3011	74		0.0 V	0.0.1/	0.0 V	0.0 V			<del>├</del> ──		-	1/	+	<b>├</b> ──	+	<b>├</b>					-		-60	-130	+
, ,			74			0.0 V	0.0 V	0.0 V					1											QA		ı	
		"	75						0.0 V	0.0 V	0.0 V		"	"									"	QB	"	"	-
, ,			76				1		5.5 V	5.5 V		0.0 V			1								"	QB	"		-
, ,			77			†	+	†			†				0.0 V		5.5 V	5.5 V					"	QC			
, ,			78				1	†			<b>†</b>		"			0.0 V	0.0 V	0.0 V					"		"	-	
			79			<del>                                     </del>	<del>                                     </del>	-			<del>                                     </del>			-	$\vdash$				0.0 V	0.0 V	0.0 V		"	QC	-	"	-
, ,					<u> </u>	Ь—		<u> </u>			ــــــ		<b></b>		<u> </u>	<u> </u>	<del></del>	<b>↓</b>					ļ	QD	igsquare	<b></b>	4
			80											"					5.5 V	5.5 V		0.0 V		QD			
, ,	I <sub>OD</sub>		81		2.5 V		0.0 V	0.0 V					"			<u> </u>	<u> </u>	<u> </u>	<u> </u>		ļ		4.5 V	QA	60		
			82			2.5 V	5.5 V	5.5 V															"	QA		<u> </u>	
			83	-					5.5 V	5.5 V	2.5 V		"	"									"	QB	"		"
, ,			84						0.0 V	0.0 V		2.5 V	"	"									"	QB	"		
, ,			85										"	"	2.5 V		0.0 V	0.0 V					"	QC	"		"
			86										"	"		2.5 V	5.5 V	5.5 V					"	QC			"
			87										"	"					5.5 V	5.5 V	2.5 V		"	QD	"		"
			88				1	†			<b>†</b>		$\Box$		1		1	<b>†</b>	0.0 V	0.0 V		2.5 V	"	QD	"	i	-
	Icc	3006	89				5.5 V	5.5 V	5.5 V	5.5 V	<b>†</b>		"		1		5.5 V	5.5 V	5.5 V	5.5 V			5.5 V	V <sub>CC</sub>		38	-
																	<u> </u>	<u> </u>	/								
2	Same t	tests, termi	nal conditi	ions and	d limits a	s subarr	วเเก 1 คระ	cent Tc =	= +125°∩	and V <sub>1</sub> ~ 1	'ests are	omitted															

See footnotes at end of device type 01.

TABLE III. <u>Group A inspection for device type 01</u>. Terminal conditions (pins not designated may be high  $\geq$  2.0 V; low  $\leq$  0.8 V; or open).

								ı ermin	iai con	aitions (	(pins r	iot aes	ignate	a may r	oe nign	≥ 2.0 V	′; low ≤ (	u.8 v; o	r open	).							
Subgroup	Symbol	MIL-STD- 883	Cases R, S, 2	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	Measured	Test	limits	Unit
		method	Test no.	S	QA	QA	IOA	I1A	I1B	IOB	QB	QB	GND	СР	QC	QC	IOC	I1C	I1D	I0D	QD	QD	V <sub>CC</sub>	terminal	Min	Max	
7	Func-	3014	90	В			В	Α	Α	В			GND	В			В	Α	Α	В			<u>2</u> /				
$Tc = 25^{\circ}C$	tional		91		L	Н		"	"	"	Н	L		Α	L	Н	"	"		"	Н	L	"				
	tests	"	92		"		"	"	"	"	"	"		В	"		"	"					"				
	3/		93		"		Α	В	"	"	"	"		В	"	"	"	"					"				
	_		94		Н	L	"	"	"	"	"	"	-	Α	"		"	"					"	1			
			95		"			"	"		"	"		В	"		"	"					"				
			96		"		В	Α	В	Α	"	"		В	"	"	"	"	"				"	1			
			97	"	L	Н	"	"	"	"	L	Н		Α	"	"	"	"	"	"		"	"	1			
			98					"	"		"	"		В	"		"	"					"				
			99					"	Α	В	"	"		В	"		Α	В				"	"				
			100		"		"	"	"	"	Н	L		Α	Н	L	"	"	"			"	"				
			101					"	"		"	"		В	"		"	"					"				
			102		"		"	"	"	"	"	"		В	"		В	Α	В	Α		"	"				
			103		"			"	"	"	"	"		A	L	Н	"	"	"	,,		Н	"				
I	1		104					"	"	"	"	"		В	-	-	"	"			-	-	"	1			J
I	1		105					"	"	"	"	"		В	"		"	"	Α	В			"	1			J
	1		106					"	"	"	"	"	"	A	"		"	"	"	"	Н		"	1			
	1		107					"	"	"	"	"	"	В	"		"	"		"	-	-	"	1			
	1		108	Α				"	"	"	"	"		В	"		"	"					"	1			J
			109	- '	Н	L		"	"		L	Н		A	Н	1	"	"				Н	"				
			110			-		"	"		-			В	"	-	"	"			-	- "	"	1			
			111				Α	В	В	Α	"	"		В	"		Α	В	В	Α			"				
			112		L	Н	A	"	В	A	Н			A	L	Н	A	В	В	A	Н		"				
			113		-		В	Α	A	В	"	-		A	-	- ''	В	A	A	В	- "	-	"				
			114		-		"	-		"				В	,		"			"		-					
			115		Н	L		"	"		L	Н		A	Н	L	"	"			L	Н	"				
			116		- "	-	Α	В	В	Α	-	- ''		A	- ''	-	Α	В	В	Α	-	- ''		1			
			117					"	"		"	,		В				"	"								
					<del> </del>	- 11	-	-	-		- 11				L	- 11							-				
			118	В	<u> </u>	H	-		-		H	-		A	<u> </u>	H	-				H	<u> </u>	-				
			119	В.										A B	-												
			120				-		-	,	- i				- "	L	-		-	-			-				
			121		H	Ŀ					L "	H		A	H	<u> </u>		^			L	H	-				
			122	-		-	В	A	A	В		- "		A	- "	-	В	A	A	В		-	- "				
			123		<u> </u>		-		"		<u> </u>		-	В	<u> </u>	<u> </u>							-				
			124		<u> </u>	Н	-	- "	"		Н	<u> </u>	-	A	L	Н	"	"		-	Н	<u> </u>	-				
	<u> </u>		125		L	Н					Н	<u> </u>		В	L	Н	. "	"			Н	L	. "				
8		tests, termi				s for sub					$_{\rm C} = -55$	C.	ONE				0.01	0.01	0.01:	0.01/			I = 0 \ '				
9	t <sub>PLH</sub>	3003	126	0.0 V	OUT	01.1=	2.7 V	0.0 V	0.0 V	0.0 V			GND	IN			0.0 V	0.0 V	0.0 V	0.0 V			5.0 V	QA	1.5	7.5	ns
Tc = 25°C	1	Fig. 4	127		1	OUT	0.0 V	"	"	0.0 V							. "	"					. "	QA			
	1		128		1	<b>†</b>		"	"	2.7 V		OUT			1		"	"					-	QB			
	1		129		1	<b>†</b>			"	0.0 V	OUT				1		"	"					"				
	1		120		1					0.0 V	551												1	QB			1 )
	1		130					"	"						OUT		2.7 V	"					"	QC			"
I	1		131	"			"	"	"	"			"	"		OUT	0.0 V	"	"	"			"	QC	"		"
	1	l ,			ļ	ļ									ļ												ᆫᆜ
	1		132		ļ	<u> </u>			"	"						<u> </u>	"	"		2.7 V		OUT		QD	"		
	1	. "	133	"	1		. "	"	"	"			. "	. "			. "	"	. "	0.0 V	OUT		"	$\overline{QD}$			"
	1		124	2.7 V	OUT	1		2.7 V							1	1		"		0.01/		-		QA			"
	1		134 135	Z./ V	001	OUT		0.0 V	-				-	-	-	-				0.0 V		<b> </b>	-				
	1		130		1	001		0.0 V															1	QA			1 1
	1		136		1	1		"	2.7 V	"		OUT					"	"					"	QB			"
	1		137		1		"	"	0.0 V		OUT		"	"			"	"		"			"				"
	1					<u> </u>																	<u> </u>	QB			
	1	"	138					"	-	"			-		OUT		"	2.7 V		=			"	QC			"
	1	"	139	"			"	"		"			"	"		OUT	"	0.0 V	"	"			"	QC	"	"	"
	1	_		-	ļ														0 =			01:-					Щ.
	1		140	-	ļ								-				<u> </u>	- "	2.7 V		OUT	OUT	<u> </u>	QD			
1	1		141		1			2.7 V									. "	"	0.0 V	"	OUT	l	. "	QD			"
						<u> </u>	1	1							<u> </u>	<u> </u>	1		1				1	<u> </u>			

See footnotes at end of device type 01.

Terminal conditions (pins not designated may be high  $\geq 2.0 \text{ V}$ ; low  $\leq 0.8 \text{ V}$ ; or open).

								CIIIIII	iai con	uitions	(Pilis i	iot des	signate	u illay t	e nign	2 2.0 V	'; IOW ≤	0.0 v, c	n open	).							
Subgroup		MIL-STD- 883	Cases R, S, 2	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	Measured	Test	limits	Unit
		method	Test no.	S	QA	QA	I0A	I1A	I1B	I0B	QB	QB	GND	CP	QC	QC	IOC	I1C	I1D	I0D	QD	QD	V <sub>CC</sub>	terminal	Min	Max	1
9	t <sub>PHL</sub>	3003	142	0.0 V	OUT		0.0 V	0.0 V	0.0 V	2.7 V			GND	IN			2.7 V	0.0 V	0.0 V	2.7 V			5.0 V	QA	1.5	9.5	ns
Tc = 25°C		Fig. 4	143	"		OUT	2.7 V	"	"	2.7 V			"				"	"	"	"			"	QA			"
			144					"	"	0.0 V		OUT					"	"					"	QB		-	-
		"	145	"			"	"	"	2.7 V	OUT		"				"	"	"	"			"	QB			"
			146	"				"	"	"			"	"	OUT		0.0 V	"	"	"			"	QC		-	-
			147					"		"			"			OUT	2.7 V	"		"			"	QC		"	-
			148					"	"	"						-	"	"		0.0 V		OUT	"	QD			-
			149				"	"	"	"			"				"	"	"	2.7 V	OUT	- 001	"	QD			"
			150	2.7 V	OUT		0.0 V	"	2.7 V	0.0 V							0.0 V	2.7 V	2.7 V	0.0 V			"	QA	"		- "
		"	151	"	001	OUT	"	2.7 V	2.7 V	0.0 V							"	"		"			"	QA QA		"	"
			152						0.0 V			OUT												QB			+ "
			153					"	2.7 V		OUT	001					"	"		"			"	QB		-	-
			154							,					OUT			0.0 V						QC		-	-
			155				"	"	"	"			"		001	OUT	"	2.7 V	"				"	QC QC		"	"
			156					"		"								"	0.0 V			OUT	"	QD			-
		"	157	"			"	"	"	"			"	"			"	"	2.7 V	"	OUT		"	QD		"	"
	f <sub>MAX</sub>	3003	158	0.0 V	OUT		IN2	0.0 V	0.0 V	"				IN1			"	0.0 V	0.0 V	"			5.0 V	QA	100		MHz
	<u>5</u> /	Fig. 5	159			OUT	IN2	"	"	"							"	"		"			"	QA			"
		"	160	"			0.0 V	"	"	IN2	OUT		"	"			"	"	"	"			"	QB		1	"
			161					"	"	IN2		OUT					"	"		"			"	QB			
		"	162					"	"	0.0 V			-	=	OUT		IN2	"	-	"			"	QC	-		
		"	163				"	"	"	"			"			OUT	IN2		"				"	QC			
			164				"	"	"	"			"				0.0 V	"	"	IN2	OUT		"	QD			"
			165					"	"	"			"				"	"		IN2		OUT		QD			"
			166	2.7 V	OUT			IN2	"					=			"	"		0.0 V			"	QA			"
		"	167			OUT	"	IN2	"	"			"						"				"	QA			
		"	168	"			"	0.0 V	IN2	"	OUT		"	"			"	"	"	"			"	QB			"
			169					"	IN2	"		OUT	"				"	"		"			"	QB			-
		"	170	"				"	0.0 V	"			"	"	OUT		"	IN2		"			"	QC			
		"	171					"		"			"	"		OUT		IN2	"				"	QC		ì	"
		"	172	"			"	"	"	"			"	"			"	0.0 V	IN2	"	OUT		"	QD			"
			173	"			"	"	"	"			"				"	0.0 V	IN2			OUT	"	QD			"
10	Same t	tests as sul	bgroup 9,	except 7	$\Gamma_{\rm C} = +129$	5°C and	use limit	s from ta	able I.																		

- | Same tests as subgroup 9, except | C = +12°C and use limits from table 1. |
  | Same tests as subgroup 9, except T<sub>C</sub> = -55°C and use limits from table 1. |
  | 1/ Apply all voltages, then apply 3.0 V, 0.0 V, 3.0 V to CP then make measurement. |
  | 2/ Perform function sequence at V<sub>CC</sub> = 4.5 V and repeat at V<sub>CC</sub> = 5.5 V. |
  | 3/ A = 3.0 V, B = 0.0 V or GND; H > 1.5 V, L < 1.5 V.

  - 4/ I<sub>IL</sub> limits (mA) min/max values for circuit shown:

Test	Min/Max limits in mA										
	CKT A	В	С								
IIL	25/60	03/60									

 $<sup>\</sup>underline{5}$ /  $f_{MAX}$  shall be measured only under the conditions of initial qualification and after process or design changes which may affect this parameter. For all other conditions,  $f_{MAX}$  shall be guaranteed, if not tested, to the imits specified in table III, herein.

TABLE III. Group A inspection for device type 02.

Terminal conditions (pins not designated may be high  $\ge 2.0 \text{ V}$ ; low  $\le 0.8 \text{ V}$ ; or open).

						Tei	rminal c	ondition	ıs (pins	not des	gnated	may be	e high ≥ 2	2.0 V; lo	w ≤ 0.8 \	√; or ope	en).						
		MIL-STD-	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16				
Subgroup	Symbol	883 method	Case 2 <u>1</u> /	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20	Measured terminal	Lin	nits	Unit
			Test no.	S	QA	I0A	I1A	I1B	I0B	QB	GND	CP	QC	I0C	I1C	I1D	I0D	QD	V <sub>CC</sub>		Min	Max	ı l
1	V <sub>OH</sub>	3006	1	0.8 V	-1 mA	2.0 V	0.8 V				GND	2/							V <sub>CC</sub> 4.5 V	QA	2.5		V
Tc = 25°C	0		2	2.0 V	-1 mA	0.8 V	2.0 V					-							"	QA	"		
			3	0.8 V				0.8 V	2.0 V	-1 mA										QB			-
			4	2.0 V				2.0 V	0.8 V	-1 mA									"	QB			
			5	0.8 V									-1 mA	2.0 V	0.8 V					QC			
			6	2.0 V									-1 mA	0.8 V	2.0 V					QC			-
			7	0.8 V												0.8 V	2.0 V	-1 mA	"	QD	"		"
			8	2.0 V												2.0 V	0.8 V	-1 mA	"	QD			"
	V <sub>OL</sub>	3007	9	0.8 V	20 mA	0.8 V	2.0 V												"	QA		0.5	"
			10	2.0 V	20 mA	2.0 V	0.8 V				-									QA		"	"
			11	0.8 V				2.0 V	0.8 V	20 mA									"	QB			"
			12	2.0 V				0.8 V	2.0 V	20 mA									"	QB		-	"
			13	0.8 V								"	20 mA	0.8 V	2.0 V				"	QC		"	. "
1		"	14	2.0 V								"	20 mA	2.0 V	0.8 V				"	QC		"	
1		"	15	0.8 V								"				2.0 V	0.8 V	20 mA	"	QD		"	"
		"	16	2.0 V												0.8 V	2.0 V	20 mA		QD		"	-
	V <sub>IC</sub>	1	17	-18 mA							"	"								S		-1.2	-
			18			-18 mA					"	"							"	I0A		"	
			19				-18 mA				"									I1A		"	"
			20					-18 mA			"									I1B		"	
			21						-18 mA		- "								- "	IOB			"
			22								- "	-18 mA								CP			- "
			23								- :			-18 mA	40. 4					IOC .			
			24												-18 mA	10 1				I1C			
			25													-18 mA	40. 4			I1D			<del></del>
		0040	26	0.71/													-18 mA			IOD			<del></del>
	I <sub>IH1</sub>	3010	27	2.7 V		0.71/					-								5.5 V	S		20	μA
			28 29	0.0 V		2.7 V	271/												-	I0A I1A			
			30	0.0 V			2.7 V	2.7 V											-	I1A I1B			,
			31	0.0 V				Z.7 V	2.7 V											IOB			
			32						2.1 V			2.7 V								CP			
			33									Z.1 V		2.7 V						IOC			
			34	0.0 V										Z.1 V	2.7 V				-	I1C			-
			35	0.0 V											Z.1 V	2.7 V				I1D			
			36	0.0 V							"					Z.1 V	2.7 V			IOD			-
1	I <sub>IH2</sub>		37	7.0 V	1											1				S		100	"
1	·IIIZ		38			7.0 V													"	IOA		"	"
		"	39	0.0 V			7.0 V							İ						I1A		"	-
		"	40	0.0 V				7.0 V											"	I1B		"	"
1		"	41						7.0 V										"	I0B		"	"
		"	42								-	7.0 V							"	CP		"	"
		"	43								"			7.0 V					"	I0C		"	"
		"	44	0.0 V							-				7.0 V				-	I1C		-	
1		"	45	0.0 V												7.0 V				I1D			"
		"	46								"						7.0 V			I0D			"
1	I <sub>IL</sub>	3009	47	0.5 V							-									S	<u>5</u> /	<u>5</u> /	mA
		"	48	0.0 V		0.5 V					"								"	I0A	"	"	
		. "	49	5.5 V			0.5 V												"	I1A	"		-
		. "	50	5.5 V				0.5 V											"	I1B		"	"
			51	0.0 V					0.5 V											I0B			
		".	52	5.5 V						<b></b>		0.5 V		0.51/					<u> </u>	CP			
1		"	53	0.0 V	<b></b>						-			0.5 V	0.5.1/	<b></b>				IOC			
1			54	5.5 V	<b></b>						-				0.5 V	0.51/				I1C			
			55	5.5 V												0.5 V	0.51/			I1D	-		
			56	0.0 V		l											0.5 V		L	I0D	L		لــــــــــــــــــــــــــــــــــــــ

See footnotes at end of device type 02.

TABLE III. <u>Group A inspection for device type 02</u>.

Terminal conditions (pins not designated may be high > 2.0 V; low < 0.8 V; or open).

						Tei	rminal c	ondition	ns (pins	not des	ignated	may be	e high ≥ 2	2.0 V; lo	w ≤ 0.8 \	√; or op	en).						
			Cases	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16				
		MIL-STD-	E, F																				
Subgroup	Symbol	883	Case	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20	Measured	Lim	iite	Unit
Oubgroup	Cyrribor	method	2 <u>1</u> /	2	J 3	7	3	,		3	10	12	13	17	13	17	10	13	20	terminal	LIII	iito	Offic
		moulou		_		10.4	14.4	145	IOD	0.0	OND	0.0	0.0	100	140	145	100	0.0		tomma			
		0044	Test no.	S	QA	IOA	I1A	I1B	I0B	QB	GND	CP	QC	IOC	I1C	I1D	I0D	QD	V <sub>CC</sub>	0.4	Min	Max	
1	los	3011	57		0.0 V	5.5 V	5.5 V	= = \/	551/	0.01/	GND	<u>2</u> /							5.5 V	QA	-60	-150	mA "
$Tc = 25^{\circ}C$			58					5.5 V	5.5 V	0.0 V									-	QB			
			59								- "		0.0 V	5.5 V	5.5 V		5.5.7	0.01/		QC			
			60													5.5 V	5.5 V	0.0 V		QD			
	I <sub>OD</sub>		61		2.5 V	0.0 V	0.0 V	0.01/	0.01/	0.51/									4.5 V	QA	60		
			62					0.0 V	0.0 V	2.5 V			0.5.1/	0.01/	0.01/				-	QB			-
			63									-	2.5 V	0.0 V	0.0 V	0.01/	0.01/	0.5.1/		QC	-		-
		3005	64			5.5 V	5.5 V	5.5 V	5.5 V		- "			5.5 V	5.5 V	0.0 V 5.5 V	0.0 V 5.5 V	2.5 V	5.5 V	QD			
	Icc		65	10.00						•••				5.5 V	5.5 V	5.5 V	5.5 V		5.5 V	V <sub>CC</sub>		34	
2			conditions,								1.												
3			conditions,		as subgro					e omitted.	OND					1 4			1 0/	1			
7	Func-	3014	66	B "		B "	A	A	В		GND	В		В	A	A	В		3/				
$Tc = 25^{\circ}C$	tional		67		L					L		A	L					L					
	test		68				-			-		В	"		-			- "	"				
	<u>4</u> /		69	-		A	В					В		- "			- "						
			70		Н					- :		A											
			71			- 1						В		- "		<u> </u>							
			72	-		В	Α "	В	A	<u>".</u>		В	"	- "		<u> </u>							
			73		L					Н		A		- "			- "	-					
			74						= [			В	- "			<u> </u>		- :					
			75					A	В			В	<u>.</u>	A	В	<u> </u>							
			76					-		_ <u>_</u>		A	H	"		-	- "						
			77				-			-	-	В						-	-				
			78	-			-			-		В		В	A	В	A						
			79	-			-			-		A B	L			-		H					
			80									В				A	В	-	-				
			81 82									A				A	D						
			83									В	"	"	,	-		L	-				
			84				-			-		В											
			85	Α	Н					Н		A	Н					Н					
			86							п п		В											
			87	"	"	Α	В	В	Α			В	"	Α	В	В	Α						
			88	"	L	A	В	В	A			A	L	A	В	В	A						
1			89		"	В	A	A	В			A		В	A	A	B	-		ł			
1			90			D ::	A	A	D			В	"	D "	- A	- "	D ::			ł			
1			91		Н					Н		A	Н	"				Н		ł			
1			92	"	"	Α	В	В	Α	Н		A	"	Α	В	В	Α	- 11		1			
1			93		-		"	"		Н		В	"		"	"	-		-	1			
1			94		L				-	L L		A	L	"				L	-	1			
1			95	В	-				-	-		A	"	"				-	-	1			
1			96	"								В	"							1			
1		"	97		Н					Н		A	Н	"				Н		1			
1			98	"	<del>''</del>	В	Α	Α	В	-	"	A		В	Α	Α	В	- :		1			
1		"	99		"	"	"	"	"	"		В	"	"	"	-	"			1			
1			100		L				"	L		A	L	"	"			L		1			
1		"	101		L	"			"	L		В	L	"	"			L		1			
8	Same tes	sts. terminal	conditions,	and limits	as for sub	aroup 7 e	xcept Tc =	+125°C	and T <sub>C</sub> = -	55°C.	•			•		•	•		•				
		/				J, O																	

See footnotes at end of device type 02.

TABLE III. Group A inspection for device type 02. Terminal conditions (pins not designated may be high  $\geq 2.0 \text{ V}$ ; low  $\leq 0.8 \text{ V}$ ; or open).

							iiiiiiiiai c	onanio	io (pirio	not aco	ignatea	illuy D	e mgm ≥ 2	o v, 10	W = 0.0 ·	v, or op	C11 <i>)</i> .						
		MIL-STD-	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16				
Subgroup	Symbol	883 method	Case 2 <u>1</u> /	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20	Measured terminal	Lim	nits	Unit
			Test no.	S	QA	I0A	I1A	I1B	I0B	QB	GND	CP	QC	I0C	I1C	I1D	I0D	QD	Vcc		Min	Max	
9	t <sub>PLH</sub>	3004	102	0.0 V	OUT	2.7 V	0.0 V	0.0 V	0.0 V		GND	IN		0.0 V	0.0 V	0.0 V	0.0 V		5.0 V	QA	1.5	7.5	ns
$T_C = 25^{\circ}C$		Fig. 4	103	"		"		"	2.7 V	OUT	"			0.0 V	"	"			"	QB			
		ű,	104	"		"	"	"	"		"	"	OUT	2.7 V		"	"			QC		"	
			105	"		0.0 V	"	"	"		"	"		2.7 V	"	"	2.7 V	OUT	"	QD		"	
			106	2.7 V	OUT	"	2.7 V	"	0.0 V		"	"		0.0 V	"	"	0.0 V		"	QA	"	"	
			107	"		"	"	2.7 V		OUT	"	"			"	"			"	QB		"	
			108	"		"	"	"	"		"		OUT		2.7 V	"			"	QC			
			109	"		"	"	"			"				2.7 V	2.7 V		OUT	"	QD		"	
	t <sub>PHL</sub>	"	110	0.0 V	OUT	0.0 V	0.0 V	0.0 V	2.7 V		"	"		2.7 V	0.0 V	0.0 V	2.7 V		"	QA	"	9.5	
			111	"		"	"	"	0.0 V	OUT	"	"		2.7 V	"	"			"	QB		"	
			112	"		"	"	"	"		"		OUT	0.0 V		"				QC			
			113	"		2.7 V	"	"	"		"					"	0.0 V	OUT	"	QD			
			114	2.7 V	OUT	0.0 V		2.7 V	"		"				2.7 V	2.7 V			"	QA			
			115	"		"	"	0.0 V		OUT	"	"			2.7 V	"			"	QB		"	
			116	"		"	"	"	"		"		OUT		0.0 V	"			"	QC			
			117	"		"	"	"			"				0.0 V	0.0 V		OUT	"	QD			
	f <sub>MAX</sub>	3003	118	0.0 V	OUT	IN2	0.0 V	0.0 V	0.0 V		"	IN1		0.0 V	0.0 V	0.0 V	0.0 V		"	QA	100		MHz
	6/	Fig. 5	119	"		0.0 V	"	"	IN2	OUT	"			0.0 V	"	"			"	QB			
			120	"		"	"	"	0.0 V		"		OUT	IN2	"	"	"		"	QC			
			121	"		"	"	"	"		"			0.0 V		"	IN2	OUT	"	QD			
			122	2.7 V	OUT	"	IN2	"	"		"				"	"	0.0 V		"	QA			
			123	"		"	0.0 V	IN2		OUT	"	"		"	"	"	"		"	QB			
			124	"		"	"	0.0 V	"		"		OUT		IN2	"			"	QC			
			125	"		"	"	0.0 V			"				0.0 V	IN2		OUT	"	QD			
10	Same te	sts, terminal	conditions,	and limits	as for sub	group 9, e	xcept T <sub>C</sub> =	+125°C a	ind use lim	its from ta	ıble I.				•			_					

- $\underline{1}/$  For case 2, pins not referenced are NC.  $\underline{2}/$  Apply all voltages, then apply 3.0 V, 0.0 V, 3.0 V to CP then make measurement.  $\underline{3}/$  Perform function sequence at V<sub>CC</sub> = 4.5 V and repeat at V<sub>CC</sub> = 5.5 V.  $\underline{4}/$  A = 3.0 V, B = 0.0 V or GND; H > 1.5 V, L < 1.5 V.  $\underline{5}/$  I<sub>IL</sub> limits (mA) min/max values for circuit shown:

Same tests, terminal conditions and limits as for subgroup 9, except T<sub>C</sub> = -55°C and use limits from table I.

Test	Min/Max limits in mA										
	CKT A	В	С								
I <sub>IL</sub>	25/60	03/60									

 $<sup>\</sup>underline{6}$ /  $f_{MAX}$  shall be measured only under the conditions of initial qualification and after process or design changes which may affect this parameter. For all other conditions,  $f_{MAX}$  shall be guaranteed, if not tested, to the imits specified in table III, herein.

# 5. PACKAGING

5.1 <u>Packaging requirements.</u> For acquisition purposes, the packaging requirements shall be as specified in the contract or order (see 6.2). When actual packaging of materiel is to be performed by DoD or in-house contractor personnel, these personnel need to contact the responsible packaging activity to ascertain packaging requirements. Packaging requirements are maintained by the Inventory Control Point's packaging activity within the Military Service or Defense Agency, or within the military service's system command. Packaging data retrieval is available from the managing Military Department's or Defense Agency's automated packaging files, CD-ROM products, or by contacting the responsible packaging activity.

# 6. NOTES

- 6.1 <u>Intended use.</u> Microcircuits conforming to this specification are intended for original equipment design applications and logistic support of existing equipment.
  - 6.2 Acquisition requirements. Acquisition documents should specify the following:
    - a. Title, number, and date of the specification.
    - b. PIN and compliance identifier, if applicable (see 1.2).
    - c. Requirements for delivery of one copy of the conformance inspection data pertinent to the device inspection lot to be supplied with each shipment by the device manufacturer, if applicable.
    - d. Requirements for certificate of compliance, if applicable.
    - e. Requirements for notification of change of product or process to contracting activity in addition to notification to the qualifying activity, if applicable.
    - f. Requirements for failure analysis (including required test condition of method 5003 of MIL-STD-883), corrective action, and reporting of results, if applicable.
    - g. Requirements for product assurance options.
    - h. Requirements for special carriers, lead lengths, or lead forming, if applicable. These requirements should not affect the part number. Unless otherwise specified, these requirements will not apply to direct purchase by or direct shipment to the Government.
    - i. Requirements for "JAN" marking.
    - j. Packaging requirements (see 5.1).
- 6.3 <u>Superseding information</u>. The requirements of MIL-M-38510 have been superseded to take advantage of the available Qualified Manufacturer Listing (QML) system provided by MIL-PRF-38535. Previous references to MIL-M-38510 in this document have been replaced by appropriate references to MIL-PRF-38535. All technical requirements now consist of this specification and MIL-PRF-38535. The MIL-M-38510 specification sheet number and PIN have been retained to avoid adversely impacting existing government logistics systems and contractor's parts lists.
- 6.4 <u>Qualification</u>. With respect to products requiring qualification, awards will be made only for products which are, at the time of award of contract, qualified for inclusion in Qualified Manufacturers List QML-38535 whether or not such products have actually been so listed by that date. The attention of the contractors is called to these requirements, and manufacturers are urged to arrange to have the products that they propose to offer to the Federal Government tested for qualification in order that they may be eligible to be awarded contracts or purchase orders for the products covered by this specification. Information pertaining to qualification of products may be obtained from DSCC-VQ, 3990 E. Broad Street, Columbus, Ohio 43123-1199.

6.5 <u>Abbreviations, symbols, and definitions.</u> The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535, MIL-HDBK-1331, and as follows:

GND	Ground zero voltage potential
I <sub>IN</sub>	Current flowing into an input terminal
V <sub>IN</sub>	Voltage level at an input terminal

- 6.6 <u>Logistic support.</u> Lead materials and finishes (see 3.4) are interchangeable. Unless otherwise specified, microcircuits acquired for Government logistic support will be acquired to device class B (see 1.2.2), lead material and finish A (see 3.4). Longer length leads and lead forming should not affect the part number.
- 6.7 <u>Substitutability.</u> The cross-reference information below is presented for the convenience of users. Microcircuits covered by this specification will functionally replace the listed generic-industry type. Generic-industry microcircuit types may not have equivalent operational performance characteristics across military temperature ranges or reliability factors equivalent to MIL-M-35810 device types and may have slight physical variations in relation to case size. The presence of this information should not be deemed as permitting substitution of generic-industry types for MIL-M-38510 types or as a waiver of any of the provisions of MIL-PRF-38535.

Military device	Generic-industry						
type	type						
01	54F398						
02	54F399						

6.8 <u>Manufacturers' designation.</u> Manufacturers' circuits which form a part of this specification are designated with an "X" as shown in table IV herein.

TABLE IV. Manufacturers' designations.

	Manufacturer's designation										
Device	Circuit A	Circuit B	Circuit C								
type	National Semiconductor/ Fairchild Semiconductor	Motorola Inc.	Signetics Corp.								
01	X										
02	X		_								

6.9 <u>Changes from previous issue.</u> Marginal notations are not used in this revision to identify changes with respect to the previous issue due to the extensiveness of the changes.

Preparing activity: DLA - CC Custodians: Army - CR Navy - EC Air Force - 11

(Project 5962-2041)

DLA - CC

Review activities: Army - MI, SM Navy - AS, CG, MC, SH, TD Air Force - 03, 19, 99

NOTE: The activities listed above were interested in this document as of the date of this document. Since organizations and responsibilities can change, you should verify the currency of the information above using the ASSIST Online database at <a href="https://www.dodssp.daps.mil">www.dodssp.daps.mil</a>.